

Shixian Liu

Email: sxliu98@gmail.com Website: www.sxliu.site

Profile: **Ph.D. Candidate**, specializing in **micro- and nanoscale heat conduction**, phonon transport, machine learning, and Monte Carlo simulations.

Programming Skills: Matlab, Python, Fortran Computational Tools: VASP, QE, phono3py, ShengBTE



PROFESSIONAL EXPERIENCE

Bauman Moscow State Technical University , Dept. of Thermophysics, <i>Assistant</i>	09.2025 – Present
<ul style="list-style-type: none">Teaching the graduate core course “<i>Thermalphysics of Nano-Systems</i>”.Assisting in teaching the general course “<i>Mathematical Modeling of Physical Problems</i>”, focusing on Python and machine learning.	

EDUCATION

Bauman Moscow State Technical University , <i>Ph.D. Candidate</i>	09.2023 – Present
<ul style="list-style-type: none">Thermal Physics and Theoretical Heat Engineering (CSC International Cooperation Program)	
Bauman Moscow State Technical University , <i>M.Sc.</i>	09.2021 - 07.2023
<ul style="list-style-type: none">Nuclear Power and Thermal Physics (CSC International Cooperation Program)	
Moscow Power Engineering Institute , <i>B.Sc.</i>	09.2019 - 07.2021
<ul style="list-style-type: none">Nuclear Power and Thermal Physics (CSC Outstanding Undergraduate International Exchange Program)	
North China Electric Power University , <i>B.Sc.</i>	09.2017 - 07.2021
<ul style="list-style-type: none">Nuclear Engineering and Nuclear Technology	

RESEARCH EXPERIENCE

Doctoral Research: Thermophysical Properties and Regulation of Nanostructures	2023–2027
<ul style="list-style-type: none">Systematic investigation of quantum confinement effects on specific heat capacity of nanostructures at low temperatures, revealing microscopic mechanisms of anomalous heat capacity.Analyzed particle-like and wave-like contributions in phonon transport; proposed the novel concept of “resonance hybridization depth” to quantify coupling strength.Developed a 3D ensemble phonon Monte Carlo simulation code, applicable to chip thermal management problems in complex multi-boundary structures.	

PUBLICATIONS

Journal Articles: 8 SCI publications (6 as first author)

1. **Liu S.**, Zhang G., Yin F., Barinov A.A., Khvesuk V.I., Yang N. Temperature Dependence of Specific Heat Capacity of Nanostructures via Neural Evolution Potential. *J. Appl. Phys.*, 2025. [Q2] [IF 2.5]
2. **Liu S.**#, Zong Z.#, Yin F., Khvesuk V.I., Yang N. Quantifying Particle and Wave Effects in Phonon Transport of Pillared Graphene Nanoribbons. *Int. J. Therm. Sci.*, 2025, **217**, 110067. [Q1] [IF 5.0]
3. **Liu S.**, Khvesuk V.I. Temperature Fluctuations in Quantum Dots: Insights from a T3/2 Heat Capacity Model. *Phys. Lett. A*, 2025, **534**, 130261. [Q2] [IF 2.6]
4. **Liu S.**, Yin F., Khvesuk V.I. Investigating Anisotropic Three-Phonon Interactions in Graphene’s Thermal Conductivity Using Monte Carlo Method. *Int. J. Thermophys.*, 2025, **46**(2), 22. [Q2] [IF 2.9]
5. **Liu S.**, Barinov A.A., Yin F., Khvesuk V.I. Determination of Thermal Properties of Unsmooth Si Nanowires. *Chin. Phys. Lett.*, 2024, **41**(1), 016301. [Q1] [IF 4.2]
6. **Liu S.**, Yin F., Melikhov V.I., Melikhov O.I. Validation of the STEG Code Using Experiments on Two-Phase Flow Across Horizontal Tube Bundles. *Nucl. Eng. Des.*, 2022, **399**, 112048. [Q1] [IF 2.1]
7. Yin F., **Liu S.**, Barinov A.A., Khvesuk V.I. An Enhanced Framework for Wave Reflection from a Periodically Rough Boundary. *Phys. B: Condens. Matter.*, 2025, **716**, 417743. [Q2] [IF 2.8]
8. Zhou Z., He Y., **Liu S.**, Yang L., Yang N. Effect of Non-Fourier Heat Transport on Temperature Distribution in High Bandwidth Memory. *IEEE Trans. Electron Devices*, 2025. [Q2] [IF 3.2]

Other Achievements: Participated in 10+ international conferences (Russia, China, Belarus).